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#### What is "[Embedded - Microcontrollers](#)"?

"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

#### Applications of "[Embedded - Microcontrollers](#)"

##### Details

Product Status	Obsolete
Core Processor	R8C
Core Size	16-Bit
Speed	20MHz
Connectivity	I <sup>2</sup> C, LINbus, SIO, SSU, UART/USART
Peripherals	POR, PWM, Voltage Detect, WDT
Number of I/O	47
Program Memory Size	48KB (48K x 8)
Program Memory Type	FLASH
EEPROM Size	4K x 8
RAM Size	4K x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 5.5V
Data Converters	A/D 12x10b; D/A 2x8b
Oscillator Type	Internal
Operating Temperature	-20°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	52-LQFP
Supplier Device Package	52-LQFP (10x10)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f21357mnfp-v0">https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f21357mnfp-v0</a>

### 1.1.2 Specifications

Tables 1.1 and 1.2 outline the Specifications for R8C/35M Group.

**Table 1.1 Specifications for R8C/35M Group (1)**

Item	Function	Specification
CPU	Central processing unit	R8C CPU core <ul style="list-style-type: none"> <li>Number of fundamental instructions: 89</li> <li>Minimum instruction execution time: 50 ns (<math>f(XIN) = 20</math> MHz, VCC = 2.7 to 5.5 V) 200 ns (<math>f(XIN) = 5</math> MHz, VCC = 1.8 to 5.5 V)</li> <li>Multiplier: 16 bits <math>\times</math> 16 bits <math>\rightarrow</math> 32 bits</li> <li>Multiply-accumulate instruction: 16 bits <math>\times</math> 16 bits + 32 bits <math>\rightarrow</math> 32 bits</li> <li>Operation mode: Single-chip mode (address space: 1 Mbyte)</li> </ul>
Memory	ROM, RAM, Data flash	Refer to <b>Table 1.3 Product List for R8C/35M Group</b> .
Power Supply Voltage Detection	Voltage detection circuit	<ul style="list-style-type: none"> <li>Power-on reset</li> <li>Voltage detection 3 (detection level of voltage detection 0 and voltage detection 1 selectable)</li> </ul>
I/O Ports	Programmable I/O ports	<ul style="list-style-type: none"> <li>Input-only: 1 pin</li> <li>CMOS I/O ports: 47, selectable pull-up resistor</li> <li>High current drive ports: 47</li> </ul>
Clock	Clock generation circuits	4 circuits: XIN clock oscillation circuit, XCIN clock oscillation circuit (32 kHz), High-speed on-chip oscillator (with frequency adjustment function), Low-speed on-chip oscillator <ul style="list-style-type: none"> <li>Oscillation stop detection: XIN clock oscillation stop detection function</li> <li>Frequency divider circuit: Dividing selectable 1, 2, 4, 8, and 16</li> <li>Low power consumption modes: Standard operating mode (high-speed clock, low-speed clock, high-speed on-chip oscillator, low-speed on-chip oscillator), wait mode, stop mode</li> </ul>
		Real-time clock (timer RE)
Interrupts		<ul style="list-style-type: none"> <li>Number of interrupt vectors: 69</li> <li>External Interrupt: 9 (INT <math>\times</math> 5, Key input <math>\times</math> 4)</li> <li>Priority levels: 7 levels</li> </ul>
Watchdog Timer		<ul style="list-style-type: none"> <li>14 bits <math>\times</math> 1 (with prescaler)</li> <li>Reset start selectable</li> <li>Low-speed on-chip oscillator for watchdog timer selectable</li> </ul>
DTC (Data Transfer Controller)		<ul style="list-style-type: none"> <li>1 channel</li> <li>Activation sources: 33</li> <li>Transfer modes: 2 (normal mode, repeat mode)</li> </ul>
Timer	Timer RA	8 bits $\times$ 1 (with 8-bit prescaler) Timer mode (period timer), pulse output mode (output level inverted every period), event counter mode, pulse width measurement mode, pulse period measurement mode
	Timer RB	8 bits $\times$ 1 (with 8-bit prescaler) Timer mode (period timer), programmable waveform generation mode (PWM output), programmable one-shot generation mode, programmable wait one-shot generation mode
	Timer RC	16 bits $\times$ 1 (with 4 capture/compare registers) Timer mode (input capture function, output compare function), PWM mode (output 3 pins), PWM2 mode (PWM output pin)
	Timer RD	16 bits $\times$ 2 (with 4 capture/compare registers) Timer mode (input capture function, output compare function), PWM mode (output 6 pins), reset synchronous PWM mode (output three-phase waveforms (6 pins), sawtooth wave modulation), complementary PWM mode (output three-phase waveforms (6 pins), triangular wave modulation), PWM3 mode (PWM output 2 pins with fixed period)
	Timer RE	8 bits $\times$ 1 Real-time clock mode (count seconds, minutes, hours, days of week), output compare mode

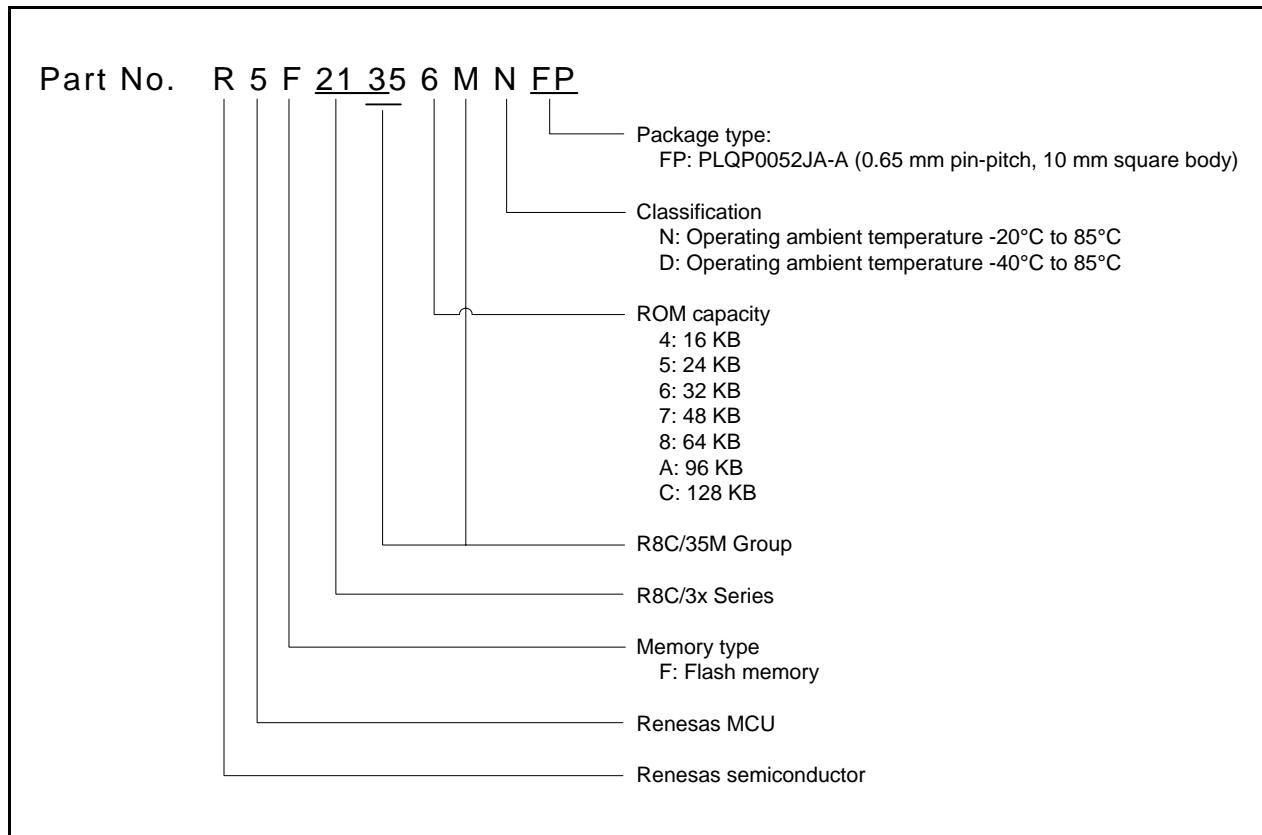
## 1.2 Product List

Table 1.3 lists Product List for R8C/35M Group, and Figure 1.1 shows a Part Number, Memory Size, and Package of R8C/35M Group.

**Table 1.3 Product List for R8C/35M Group**

**Current of Jun 2011**

Part No.	ROM Capacity		RAM Capacity	Package Type	Remarks
	Program ROM	Data flash			
R5F21354MNFP	16 Kbytes	1 Kbyte × 4	1.5 Kbytes	PLQP0052JA-A	N version
R5F21355MNFP	24 Kbytes	1 Kbyte × 4	2 Kbytes	PLQP0052JA-A	
R5F21356MNFP	32 Kbytes	1 Kbyte × 4	2.5 Kbytes	PLQP0052JA-A	
R5F21357MNFP	48 Kbytes	1 Kbyte × 4	4 Kbytes	PLQP0052JA-A	
R5F21358MNFP	64 Kbytes	1 Kbyte × 4	6 Kbytes	PLQP0052JA-A	
R5F2135AMNFP	96 Kbytes	1 Kbyte × 4	8 Kbytes	PLQP0052JA-A	
R5F2135CMNFP	128 Kbytes	1 Kbyte × 4	10 Kbytes	PLQP0052JA-A	
R5F21354MDFP	16 Kbytes	1 Kbyte × 4	1.5 Kbytes	PLQP0052JA-A	D version
R5F21355MDFP	24 Kbytes	1 Kbyte × 4	2 Kbytes	PLQP0052JA-A	
R5F21356MDFP	32 Kbytes	1 Kbyte × 4	2.5 Kbytes	PLQP0052JA-A	
R5F21357MDFP	48 Kbytes	1 Kbyte × 4	4 Kbytes	PLQP0052JA-A	
R5F21358MDFP	64 Kbytes	1 Kbyte × 4	6 Kbytes	PLQP0052JA-A	
R5F2135AMD FP	96 Kbytes	1 Kbyte × 4	8 Kbytes	PLQP0052JA-A	
R5F2135CMD FP	128 Kbytes	1 Kbyte × 4	10 Kbytes	PLQP0052JA-A	



**Figure 1.1 Part Number, Memory Size, and Package of R8C/35M Group**

**Table 1.4 Pin Name Information by Pin Number (1)**

Pin Number	Control Pin	Port	I/O Pin Functions for Peripheral Modules					
			Interrupt	Timer	Serial Interface	SSU	I <sup>2</sup> C bus	A/D Converter, D/A Converter, Comparator A, Comparator B
1		P5_6		(TRA0)				
2		P3_2	(INT1/INT2)	(TRAIO)				
3		P3_0		(TRA0)				
4		P4_2						VREF
5	MODE							
6	(XCIN)	P4_3						
7	(XCOUT)	P4_4						
8	RESET							
9	XOUT	P4_7						
10	VSS/AVSS							
11	XIN	P4_6						
12	VCC/AVCC							
13		P3_7		TRA0	(RXD2/SCL2/ TXD2/SDA2)	SSO	SDA	
14		P3_5		(TRCIOD)	(CLK2)	SSCK	SCL	
15		P3_4		(TRCIOC)	(RXD2/SCL2/ TXD2/SDA2)	SSI		IVREF3
16		P3_3	INT3	(TRCCLK)	(CTS2/RTS2)	SCS		IVCMP3
17		P2_7		(TRDIOD1)				
18		P2_6		(TRDIOC1)				
19		P2_5		(TRDIOB1)				
20		P2_4		(TRDIOA1)				
21		P2_3		(TRDIOD0)				
22		P2_2		(TRCIOD/ TRDIOB0)				
23		P2_1		(TRCIOC/ TRDIOC0)				
24		P2_0	INT1	(TRCIOB/ TRDIOA0/ TRDCLK)				
25		P3_6	INT1					
26		P3_1		(TRBO)				
27		P6_7	INT3	(TRCIOD)				
28		P6_6	INT2	(TRCIOC)	(TXD2/SDA2)			
29		P6_5	INT4	(TRCIOB)	(CLK1/CLK2)			
30		P4_5	INT0		(RXD2/SCL2)			ADTRG
31		P1_7	INT1	(TRAIO)				IVCMP1
32		P1_6			(CLK0)			LVCOUT2/IVREF1
33		P1_5	INT1	(TRAIO)	(RXD0)			
34		P1_4		(TRCCLK)	(TXD0)			
35		P1_3	KI3	TRBO (TRCIOC)				AN11/LVCOUT1

Note:

1. Can be assigned to the pin in parentheses by a program.

**Table 1.5 Pin Name Information by Pin Number (2)**

Pin Number	Control Pin	Port	I/O Pin Functions for Peripheral Modules					
			Interrupt	Timer	Serial Interface	SSU	I <sup>2</sup> C bus	A/D Converter, D/A Converter, Comparator A, Comparator B
36		P1_2	KI2	(TRCIOB)				AN10/LVREF
37		P1_1	KI1	(TRCIOA/ TRCTRG)				AN9/LVCMP2
38		P1_0	KI0	(TRCIOD)				AN8/LVCMP1
39		P0_7		(TRCIOC)				AN0/DA1
40		P0_6		(TRCIOD)				AN1/DA0
41		P0_5		(TRCIOB)				AN2
42		P0_4		TREO (/TRCIOB)				AN3
43		P0_3		(TRCIOB)	(CLK1)			AN4
44		P0_2		(TRCIOA/ TRCTRG)	(RXD1)			AN5
45		P0_1		(TRCIOA/ TRCTRG)	(TXD1)			AN6
46		P0_0		(TRCIOA/ TRCTRG)				AN7
47		P6_4			(RXD1)			
48		P6_3			(TXD1)			
49		P6_2			(CLK1)			
50		P6_1						
51		P6_0		(TREO)				
52		P5_7						

Note:

1. Can be assigned to the pin in parentheses by a program.

## 1.5 Pin Functions

Tables 1.6 and 1.7 list Pin Functions.

**Table 1.6 Pin Functions (1)**

Item	Pin Name	I/O Type	Description
Power supply input	VCC, VSS	—	Apply 1.8 V to 5.5 V to the VCC pin. Apply 0 V to the VSS pin.
Analog power supply input	AVCC, AVSS	—	Power supply for the A/D converter. Connect a capacitor between AVCC and AVSS.
Reset input	RESET	I	Input “L” on this pin resets the MCU.
MODE	MODE	I	Connect this pin to VCC via a resistor.
XIN clock input	XIN	I	These pins are provided for XIN clock generation circuit I/O. Connect a ceramic resonator or a crystal oscillator between the XIN and XOUT pins <sup>(1)</sup> . To use an external clock, input it to the XOUT pin and leave the XIN pin open.
XIN clock output	XOUT	I/O	
XCIN clock input	XCIN	I	These pins are provided for XCIN clock generation circuit I/O. Connect a crystal oscillator between the XCIN and XCOUT pins <sup>(1)</sup> . To use an external clock, input it to the XCIN pin and leave the XCOUT pin open.
XCIN clock output	XCOUT	O	
INT interrupt input	INT0 to INT4	I	INT interrupt input pins. INT0 is timer RB, RC and RD input pin.
Key input interrupt	KI0 to KI3	I	Key input interrupt input pins
Timer RA	TRAIO	I/O	Timer RA I/O pin
	TRAO	O	Timer RA output pin
Timer RB	TRBO	O	Timer RB output pin
Timer RC	TRCCLK	I	External clock input pin
	TRCTRG	I	External trigger input pin
	TRCIOA, TRCIOB, TRCIOD, TRCIOD	I/O	Timer RC I/O pins
Timer RD	TRDIOA0, TRDIOA1, TRDIOB0, TRDIOB1, TRDIOD0, TRDIOD1	I/O	Timer RD I/O pins
	TRDCLK	I	External clock input pin
Timer RE	TREO	O	Divided clock output pin
Serial interface	CLK0, CLK1, CLK2	I/O	Transfer clock I/O pins
	RXD0, RXD1, RXD2	I	Serial data input pins
	TXD0, TXD1, TXD2	O	Serial data output pins
	CTS2	I	Transmission control input pin
	RTS2	O	Reception control output pin
	SCL2	I/O	I <sup>2</sup> C mode clock I/O pin
I <sup>2</sup> C bus	SDA2	I/O	I <sup>2</sup> C mode data I/O pin
	SCL	I/O	Clock I/O pin
SSU	SDA	I/O	Data I/O pin
	SSI	I/O	Data I/O pin
	SCS	I/O	Chip-select signal I/O pin
	SSCK	I/O	Clock I/O pin
SSO	SSO	I/O	Data I/O pin

I: Input      O: Output      I/O: Input and output

Note:

1. Refer to the oscillator manufacturer for oscillation characteristics.

## 2.1 Data Registers (R0, R1, R2, and R3)

R0 is a 16-bit register for transfer, arithmetic, and logic operations. The same applies to R1 to R3. R0 can be split into high-order bits (R0H) and low-order bits (R0L) to be used separately as 8-bit data registers. R1H and R1L are analogous to R0H and R0L. R2 can be combined with R0 and used as a 32-bit data register (R2R0). R3R1 is analogous to R2R0.

## 2.2 Address Registers (A0 and A1)

A0 is a 16-bit register for address register indirect addressing and address register relative addressing. It is also used for transfer, arithmetic, and logic operations. A1 is analogous to A0. A1 can be combined with A0 and as a 32-bit address register (A1A0).

## 2.3 Frame Base Register (FB)

FB is a 16-bit register for FB relative addressing.

## 2.4 Interrupt Table Register (INTB)

INTB is a 20-bit register that indicates the starting address of an interrupt vector table.

## 2.5 Program Counter (PC)

PC is 20 bits wide and indicates the address of the next instruction to be executed.

## 2.6 User Stack Pointer (USP) and Interrupt Stack Pointer (ISP)

The stack pointers (SP), USP and ISP, are each 16 bits wide. The U flag of FLG is used to switch between USP and ISP.

## 2.7 Static Base Register (SB)

SB is a 16-bit register for SB relative addressing.

## 2.8 Flag Register (FLG)

FLG is an 11-bit register indicating the CPU state.

### 2.8.1 Carry Flag (C)

The C flag retains carry, borrow, or shift-out bits that have been generated by the arithmetic and logic unit.

### 2.8.2 Debug Flag (D)

The D flag is for debugging only. Set it to 0.

### 2.8.3 Zero Flag (Z)

The Z flag is set to 1 when an arithmetic operation results in 0; otherwise to 0.

### 2.8.4 Sign Flag (S)

The S flag is set to 1 when an arithmetic operation results in a negative value; otherwise to 0.

### 2.8.5 Register Bank Select Flag (B)

Register bank 0 is selected when the B flag is 0. Register bank 1 is selected when this flag is set to 1.

### 2.8.6 Overflow Flag (O)

The O flag is set to 1 when an operation results in an overflow; otherwise to 0.

### 2.8.7 Interrupt Enable Flag (I)

The I flag enables maskable interrupts.

Interrupts are disabled when the I flag is set to 0, and are enabled when the I flag is set to 1. The I flag is set to 0 when an interrupt request is acknowledged.

### 2.8.8 Stack Pointer Select Flag (U)

ISP is selected when the U flag is set to 0; USP is selected when the U flag is set to 1.

The U flag is set to 0 when a hardware interrupt request is acknowledged or the INT instruction of software interrupt numbers 0 to 31 is executed.

### 2.8.9 Processor Interrupt Priority Level (IPL)

IPL is 3 bits wide and assigns processor interrupt priority levels from level 0 to level 7.

If a requested interrupt has higher priority than IPL, the interrupt is enabled.

### 2.8.10 Reserved Bit

If necessary, set to 0. When read, the content is undefined.

**Table 4.4 SFR Information (4) (1)**

Address	Register	Symbol	After Reset
00C0h	A/D Register 0	AD0	XXh 000000XXb
00C1h			
00C2h	A/D Register 1	AD1	XXh 000000XXb
00C3h			
00C4h	A/D Register 2	AD2	XXh 000000XXb
00C5h			
00C6h	A/D Register 3	AD3	XXh 000000XXb
00C7h			
00C8h	A/D Register 4	AD4	XXh 000000XXb
00C9h			
00CAh	A/D Register 5	AD5	XXh 000000XXb
00CBh			
00CCh	A/D Register 6	AD6	XXh 000000XXb
00CDh			
00CEh	A/D Register 7	AD7	XXh 000000XXb
00CFh			
00D0h			
00D1h			
00D2h			
00D3h			
00D4h	A/D Mode Register	ADMOD	00h
00D5h	A/D Input Select Register	ADINSEL	1100000b
00D6h	A/D Control Register 0	ADCON0	00h
00D7h	A/D Control Register 1	ADCON1	00h
00D8h	D/A0 Register	DA0	00h
00D9h	D/A1 Register	DA1	00h
00DAh			
00DBh			
00DCh	D/A Control Register	DACON	00h
00DDh			
00DEh			
00DFh			
00E0h	Port P0 Register	P0	XXh
00E1h	Port P1 Register	P1	XXh
00E2h	Port P0 Direction Register	PD0	00h
00E3h	Port P1 Direction Register	PD1	00h
00E4h	Port P2 Register	P2	XXh
00E5h	Port P3 Register	P3	XXh
00E6h	Port P2 Direction Register	PD2	00h
00E7h	Port P3 Direction Register	PD3	00h
00E8h	Port P4 Register	P4	XXh
00E9h	Port P5 Register	P5	XXh
00EAh	Port P4 Direction Register	PD4	00h
00EBh	Port P5 Direction Register	PD5	00h
00ECb	Port P6 Register	P6	XXh
00EDh			
00EEh	Port P6 Direction Register	PD6	00h
00EFh			
00F0h			
00F1h			
00F2h			
00F3h			
00F4h			
00F5h			
00F6h			
00F7h			
00F8h			
00F9h			
00FAh			
00FBh			
00FCb			
00FDh			
00FEh			
00FFh			

X: Undefined

Note:

- The blank areas are reserved and cannot be accessed by users.

**Table 4.6 SFR Information (6) (1)**

Address	Register	Symbol	After Reset
0140h	Timer RD Control Register 0	TRDCR0	00h
0141h	Timer RD I/O Control Register A0	TRDIORA0	10001000b
0142h	Timer RD I/O Control Register C0	TRDIORC0	10001000b
0143h	Timer RD Status Register 0	TRDSR0	11100000b
0144h	Timer RD Interrupt Enable Register 0	TRDIER0	11100000b
0145h	Timer RD PWM Mode Output Level Control Register 0	TRDPOCR0	11111000b
0146h	Timer RD Counter 0	TRD0	00h 00h
0147h			
0148h	Timer RD General Register A0	TRDGRA0	FFh FFh
0149h			
014Ah	Timer RD General Register B0	TRDGRB0	FFh FFh
014Bh			
014Ch	Timer RD General Register C0	TRDGRC0	FFh FFh
014Dh			
014Eh	Timer RD General Register D0	TRDGRD0	FFh FFh
014Fh			
0150h	Timer RD Control Register 1	TRDCR1	00h
0151h	Timer RD I/O Control Register A1	TRDIORA1	10001000b
0152h	Timer RD I/O Control Register C1	TRDIORC1	10001000b
0153h	Timer RD Status Register 1	TRDSR1	11000000b
0154h	Timer RD Interrupt Enable Register 1	TRDIER1	11100000b
0155h	Timer RD PWM Mode Output Level Control Register 1	TRDPOCR1	11111000b
0156h	Timer RD Counter 1	TRD1	00h 00h
0157h			
0158h	Timer RD General Register A1	TRDGRA1	FFh FFh
0159h			
015Ah	Timer RD General Register B1	TRDGRB1	FFh FFh
015Bh			
015Ch	Timer RD General Register C1	TRDGRC1	FFh FFh
015Dh			
015Eh	Timer RD General Register D1	TRDGRD1	FFh FFh
015Fh			
0160h	UART1 Transmit/Receive Mode Register	U1MR	00h
0161h	UART1 Bit Rate Register	U1BRG	X <sub>X</sub> h
0162h	UART1 Transmit Buffer Register	U1TB	X <sub>X</sub> h X <sub>X</sub> h
0163h			
0164h	UART1 Transmit/Receive Control Register 0	U1C0	00001000b
0165h	UART1 Transmit/Receive Control Register 1	U1C1	00000010b
0166h	UART1 Receive Buffer Register	U1RB	X <sub>X</sub> h X <sub>X</sub> h
0167h			
0168h			
0169h			
016Ah			
016Bh			
016Ch			
016Dh			
016Eh			
016Fh			
0170h			
0171h			
0172h			
0173h			
0174h			
0175h			
0176h			
0177h			
0178h			
0179h			
017Ah			
017Bh			
017Ch			
017Dh			
017Eh			
017Fh			

X: Undefined

Note:

- The blank areas are reserved and cannot be accessed by users.

**Table 4.8 SFR Information (8) (1)**

Address	Register	Symbol	After Reset
01C0h	Address Match Interrupt Register 0	RMAD0	XXh XXh 0000XXXXb
01C1h			
01C2h			
01C3h	Address Match Interrupt Enable Register 0	AIER0	00h
01C4h	Address Match Interrupt Register 1	RMAD1	XXh XXh 0000XXXXb
01C5h			
01C6h			
01C7h	Address Match Interrupt Enable Register 1	AIER1	00h
01C8h			
01C9h			
01CAh			
01CBh			
01CCh			
01CDh			
01CEh			
01CFh			
01D0h			
01D1h			
01D2h			
01D3h			
01D4h			
01D5h			
01D6h			
01D7h			
01D8h			
01D9h			
01DAh			
01DBh			
01DCh			
01DDh			
01DEh			
01DFh			
01E0h	Pull-Up Control Register 0	PUR0	00h
01E1h	Pull-Up Control Register 1	PUR1	00h
01E2h			
01E3h			
01E4h			
01E5h			
01E6h			
01E7h			
01E8h			
01E9h			
01EAh			
01EBh			
01ECb			
01EDh			
01EEh			
01EFh			
01F0h	Port P1 Drive Capacity Control Register	P1DRR	00h
01F1h	Port P2 Drive Capacity Control Register	P2DRR	00h
01F2h	Drive Capacity Control Register 0	DRR0	00h
01F3h	Drive Capacity Control Register 1	DRR1	00h
01F4h			
01F5h	Input Threshold Control Register 0	VLT0	00h
01F6h	Input Threshold Control Register 1	VLT1	00h
01F7h			
01F8h	Comparator B Control Register 0	INTCMP	00h
01F9h			
01FAh	External Input Enable Register 0	INTEN	00h
01FBh	External Input Enable Register 1	INTEN1	00h
01FCb	INT Input Filter Select Register 0	INTF	00h
01FDh	INT Input Filter Select Register 1	INTF1	00h
01FEh	Key Input Enable Register 0	KIEN	00h
01FFh			

X: Undefined

Note:

- The blank areas are reserved and cannot be accessed by users.

## 5. Electrical Characteristics

**Table 5.1 Absolute Maximum Ratings**

Symbol	Parameter	Condition	Rated Value	Unit
Vcc/AVcc	Supply voltage		-0.3 to 6.5	V
Vi	Input voltage		-0.3 to Vcc + 0.3	V
Vo	Output voltage		-0.3 to Vcc + 0.3	V
Pd	Power dissipation	-40°C ≤ Topr ≤ 85°C	500	mW
Topr	Operating ambient temperature		-20 to 85 (N version) / -40 to 85 (D version)	°C
Tstg	Storage temperature		-65 to 150	°C

**Table 5.2 Recommended Operating Conditions**

Symbol	Parameter			Conditions	Standard			Unit		
					Min.	Typ.	Max.			
Vcc/AVcc	Supply voltage				1.8	—	5.5	V		
Vss/AVss	Supply voltage				—	0	—	V		
VIH	Input "H" voltage	Other than CMOS input			0.8 Vcc	—	Vcc	V		
		CMOS input	Input level switching function (I/O port)	Input level selection : 0.35 Vcc	4.0 V ≤ Vcc ≤ 5.5 V	0.5 Vcc	—	Vcc		
					2.7 V ≤ Vcc < 4.0 V	0.55 Vcc	—	Vcc		
					1.8 V ≤ Vcc < 2.7 V	0.65 Vcc	—	Vcc		
		CMOS input	Input level switching function (I/O port)	Input level selection : 0.5 Vcc	4.0 V ≤ Vcc ≤ 5.5 V	0.65 Vcc	—	Vcc		
					2.7 V ≤ Vcc < 4.0 V	0.7 Vcc	—	Vcc		
					1.8 V ≤ Vcc < 2.7 V	0.8 Vcc	—	Vcc		
		CMOS input	Input level switching function (I/O port)	Input level selection : 0.7 Vcc	4.0 V ≤ Vcc ≤ 5.5 V	0.85 Vcc	—	Vcc		
					2.7 V ≤ Vcc < 4.0 V	0.85 Vcc	—	Vcc		
					1.8 V ≤ Vcc < 2.7 V	0.85 Vcc	—	Vcc		
	External clock input (XOUT)				1.2	—	Vcc	V		
VIL	Input "L" voltage	Other than CMOS input			0	—	0.2 Vcc	V		
		CMOS input	Input level switching function (I/O port)	Input level selection : 0.35 Vcc	4.0 V ≤ Vcc ≤ 5.5 V	0	—	0.2 Vcc		
					2.7 V ≤ Vcc < 4.0 V	0	—	0.2 Vcc		
					1.8 V ≤ Vcc < 2.7 V	0	—	0.2 Vcc		
		CMOS input	Input level switching function (I/O port)	Input level selection : 0.5 Vcc	4.0 V ≤ Vcc ≤ 5.5 V	0	—	0.4 Vcc		
					2.7 V ≤ Vcc < 4.0 V	0	—	0.3 Vcc		
					1.8 V ≤ Vcc < 2.7 V	0	—	0.2 Vcc		
		CMOS input	Input level switching function (I/O port)	Input level selection : 0.7 Vcc	4.0 V ≤ Vcc ≤ 5.5 V	0	—	0.55 Vcc		
					2.7 V ≤ Vcc < 4.0 V	0	—	0.45 Vcc		
					1.8 V ≤ Vcc < 2.7 V	0	—	0.35 Vcc		
	External clock input (XOUT)				0	—	0.4	V		
IOH(sum)	Peak sum output "H" current	Sum of all pins IOH(peak)			—	—	-160	mA		
IOH(sum)	Average sum output "H" current	Sum of all pins IOH(avg)			—	—	-80	mA		
IOH(peak)	Peak output "H" current	Drive capacity Low			—	—	-10	mA		
		Drive capacity High			—	—	-40	mA		
IOH(avg)	Average output "H" current	Drive capacity Low			—	—	-5	mA		
		Drive capacity High			—	—	-20	mA		
IOL(sum)	Peak sum output "L" current	Sum of all pins IOL(peak)			—	—	160	mA		
		Sum of all pins IOL(avg)			—	—	80	mA		
IOL(peak)	Peak output "L" current	Drive capacity Low			—	—	10	mA		
		Drive capacity High			—	—	40	mA		
IOL(avg)	Average output "L" current	Drive capacity Low			—	—	5	mA		
		Drive capacity High			—	—	20	mA		
f(XIN)	XIN clock input oscillation frequency			2.7 V ≤ Vcc ≤ 5.5 V	—	—	20	MHz		
				1.8 V ≤ Vcc < 2.7 V	—	—	5	MHz		
f(XCIN)	XCIN clock input oscillation frequency			1.8 V ≤ Vcc ≤ 5.5 V	—	32.768	50	kHz		
fOCO40M	When used as the count source for timer RC or timer RD (3)			2.7 V ≤ Vcc ≤ 5.5 V	32	—	40	MHz		
fOCO-F	fOCO-F frequency			2.7 V ≤ Vcc ≤ 5.5 V	—	—	20	MHz		
				1.8 V ≤ Vcc < 2.7 V	—	—	5	MHz		
—	System clock frequency			2.7 V ≤ Vcc ≤ 5.5 V	—	—	20	MHz		
				1.8 V ≤ Vcc < 2.7 V	—	—	5	MHz		
f(BCLK)	CPU clock frequency			2.7 V ≤ Vcc ≤ 5.5 V	—	—	20	MHz		
				1.8 V ≤ Vcc < 2.7 V	—	—	5	MHz		

Notes:

1. Vcc = 1.8 to 5.5 V and Topr = -20 to 85°C (N version) / -40 to 85°C (D version), unless otherwise specified.
2. The average output current indicates the average value of current measured during 100 ms.
3. fOCO40M can be used as the count source for timer RC or timer RD in the range of Vcc = 2.7 V to 5.5V.

**Table 5.7 Flash Memory (Program ROM) Electrical Characteristics**

Symbol	Parameter	Conditions	Standard			Unit
			Min.	Typ.	Max.	
–	Program/erase endurance (2)		1,000 (3)	–	–	times
–	Byte program time		–	80	500	μs
–	Block erase time		–	0.3	–	s
td(SR-SUS)	Time delay from suspend request until suspend		–	–	5+CPU clock × 3 cycles	ms
–	Interval from erase start/restart until following suspend request		0	–	–	μs
–	Time from suspend until erase restart		–	–	30+CPU clock × 1 cycle	μs
td(CMDRST-READY)	Time from when command is forcibly terminated until reading is enabled		–	–	30+CPU clock × 1 cycle	μs
–	Program, erase voltage		2.7	–	5.5	V
–	Read voltage		1.8	–	5.5	V
–	Program, erase temperature		0	–	60	°C
–	Data hold time (7)	Ambient temperature = 55°C	20	–	–	year

## Notes:

1. Vcc = 2.7 to 5.5 V and T<sub>opr</sub> = 0 to 60°C, unless otherwise specified.

2. Definition of programming/erasure endurance

The programming and erasure endurance is defined on a per-block basis.

If the programming and erasure endurance is n (n = 1,000), each block can be erased n times. For example, if 1,024 1-byte writes are performed to different addresses in block A, a 1 Kbyte block, and then the block is erased, the programming/erasure endurance still stands at one.

However, the same address must not be programmed more than once per erase operation (overwriting prohibited).

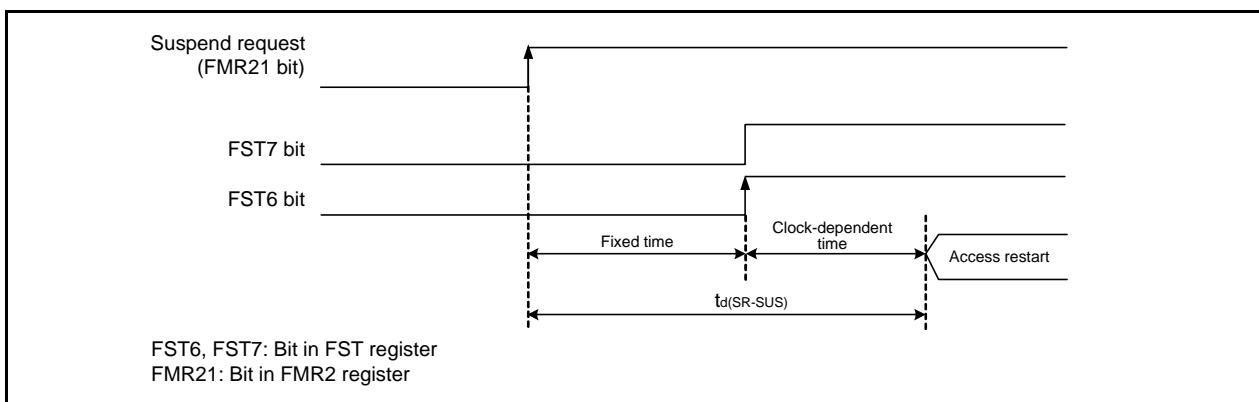
3. Endurance to guarantee all electrical characteristics after program and erase. (1 to Min. value can be guaranteed).
4. In a system that executes multiple programming operations, the actual erasure count can be reduced by writing to sequential addresses in turn so that as much of the block as possible is used up before performing an erase operation. For example, when programming groups of 16 bytes, the effective number of rewrites can be minimized by programming up to 128 groups before erasing them all in one operation. It is also advisable to retain data on the erasure endurance of each block and limit the number of erase operations to a certain number.
5. If an error occurs during block erase, attempt to execute the clear status register command, then execute the block erase command at least three times until the erase error does not occur.
6. Customers desiring program/erase failure rate information should contact their Renesas technical support representative.
7. The data hold time includes time that the power supply is off or the clock is not supplied.

**Table 5.8 Flash Memory (Data flash Block A to Block D) Electrical Characteristics**

Symbol	Parameter	Conditions	Standard			Unit
			Min.	Typ.	Max.	
–	Program/erase endurance (2)		10,000 (3)	–	–	times
–	Byte program time (program/erase endurance $\leq$ 1,000 times)		–	160	1,500	$\mu\text{s}$
–	Byte program time (program/erase endurance $>$ 1,000 times)		–	300	1,500	$\mu\text{s}$
–	Block erase time (program/erase endurance $\leq$ 1,000 times)		–	0.2	1	s
–	Block erase time (program/erase endurance $>$ 1,000 times)		–	0.3	1	s
td(SR-SUS)	Time delay from suspend request until suspend		–	–	5+CPU clock $\times$ 3 cycles	ms
–	Interval from erase start/restart until following suspend request		0	–	–	$\mu\text{s}$
–	Time from suspend until erase restart		–	–	30+CPU clock $\times$ 1 cycle	$\mu\text{s}$
td(CMDRST-READY)	Time from when command is forcibly terminated until reading is enabled		–	–	30+CPU clock $\times$ 1 cycle	$\mu\text{s}$
–	Program, erase voltage		2.7	–	5.5	V
–	Read voltage		1.8	–	5.5	V
–	Program, erase temperature		-20 (7)	–	85	$^{\circ}\text{C}$
–	Data hold time (8)	Ambient temperature = 55 $^{\circ}\text{C}$	20	–	–	year

## Notes:

1. V<sub>CC</sub> = 2.7 to 5.5 V and T<sub>OPR</sub> = -20 to 85°C (N version) / -40 to 85°C (D version), unless otherwise specified.
2. Definition of programming/erasure endurance  
The programming and erasure endurance is defined on a per-block basis.  
If the programming and erasure endurance is n (n = 10,000), each block can be erased n times. For example, if 1,024 1-byte writes are performed to different addresses in block A, a 1 Kbyte block, and then the block is erased, the programming/erasure endurance still stands at one.  
However, the same address must not be programmed more than once per erase operation (overwriting prohibited).
3. Endurance to guarantee all electrical characteristics after program and erase. (1 to Min. value can be guaranteed).
4. In a system that executes multiple programming operations, the actual erasure count can be reduced by writing to sequential addresses in turn so that as much of the block as possible is used up before performing an erase operation. For example, when programming groups of 16 bytes, the effective number of rewrites can be minimized by programming up to 128 groups before erasing them all in one operation. In addition, averaging the erasure endurance between blocks A to D can further reduce the actual erasure endurance. It is also advisable to retain data on the erasure endurance of each block and limit the number of erase operations to a certain number.
5. If an error occurs during block erase, attempt to execute the clear status register command, then execute the block erase command at least three times until the erase error does not occur.
6. Customers desiring program/erase failure rate information should contact their Renesas technical support representative.
7. -40°C for D version.
8. The data hold time includes time that the power supply is off or the clock is not supplied.

**Figure 5.2 Time delay until Suspend**

**Table 5.9 Voltage Detection 0 Circuit Electrical Characteristics**

Symbol	Parameter	Condition	Standard			Unit
			Min.	Typ.	Max.	
V <sub>det0</sub>	Voltage detection level V <sub>det0_0</sub> (2)		1.80	1.90	2.05	V
	Voltage detection level V <sub>det0_1</sub> (2)		2.15	2.35	2.50	V
	Voltage detection level V <sub>det0_2</sub> (2)		2.70	2.85	3.05	V
	Voltage detection level V <sub>det0_3</sub> (2)		3.55	3.80	4.05	V
–	Voltage detection 0 circuit response time (4)	At the falling of Vcc from 5 V to (V <sub>det0_0</sub> – 0.1) V	–	6	150	μs
–	Voltage detection circuit self power consumption	VCA25 = 1, Vcc = 5.0 V	–	1.5	–	μA
td(E-A)	Waiting time until voltage detection circuit operation starts (3)		–	–	100	μs

Notes:

1. The measurement condition is Vcc = 1.8 V to 5.5 V and Topr = –20 to 85°C (N version) / –40 to 85°C (D version).
2. Select the voltage detection level with bits VDSEL0 and VDSEL1 in the OFS register.
3. Necessary time until the voltage detection circuit operates when setting to 1 again after setting the VCA25 bit in the VCA2 register to 0.
4. Time until the voltage monitor 0 reset is generated after the voltage passes V<sub>det0</sub>.

**Table 5.10 Voltage Detection 1 Circuit Electrical Characteristics**

Symbol	Parameter	Condition	Standard			Unit
			Min.	Typ.	Max.	
V <sub>det1</sub>	Voltage detection level V <sub>det1_0</sub> (2)	At the falling of Vcc	2.00	2.20	2.40	V
	Voltage detection level V <sub>det1_1</sub> (2)	At the falling of Vcc	2.15	2.35	2.55	V
	Voltage detection level V <sub>det1_2</sub> (2)	At the falling of Vcc	2.30	2.50	2.70	V
	Voltage detection level V <sub>det1_3</sub> (2)	At the falling of Vcc	2.45	2.65	2.85	V
	Voltage detection level V <sub>det1_4</sub> (2)	At the falling of Vcc	2.60	2.80	3.00	V
	Voltage detection level V <sub>det1_5</sub> (2)	At the falling of Vcc	2.75	2.95	3.15	V
	Voltage detection level V <sub>det1_6</sub> (2)	At the falling of Vcc	2.85	3.10	3.40	V
	Voltage detection level V <sub>det1_7</sub> (2)	At the falling of Vcc	3.00	3.25	3.55	V
	Voltage detection level V <sub>det1_8</sub> (2)	At the falling of Vcc	3.15	3.40	3.70	V
	Voltage detection level V <sub>det1_9</sub> (2)	At the falling of Vcc	3.30	3.55	3.85	V
	Voltage detection level V <sub>det1_A</sub> (2)	At the falling of Vcc	3.45	3.70	4.00	V
	Voltage detection level V <sub>det1_B</sub> (2)	At the falling of Vcc	3.60	3.85	4.15	V
	Voltage detection level V <sub>det1_C</sub> (2)	At the falling of Vcc	3.75	4.00	4.30	V
	Voltage detection level V <sub>det1_D</sub> (2)	At the falling of Vcc	3.90	4.15	4.45	V
–	Hysteresis width at the rising of Vcc in voltage detection 1 circuit	V <sub>det1_0</sub> to V <sub>det1_5</sub> selected	–	0.07	–	V
		V <sub>det1_6</sub> to V <sub>det1_F</sub> selected	–	0.10	–	V
–	Voltage detection 1 circuit response time (3)	At the falling of Vcc from 5 V to (V <sub>det1_0</sub> – 0.1) V	–	60	150	μs
–	Voltage detection circuit self power consumption	VCA26 = 1, Vcc = 5.0 V	–	1.7	–	μA
td(E-A)	Waiting time until voltage detection circuit operation starts (4)		–	–	100	μs

Notes:

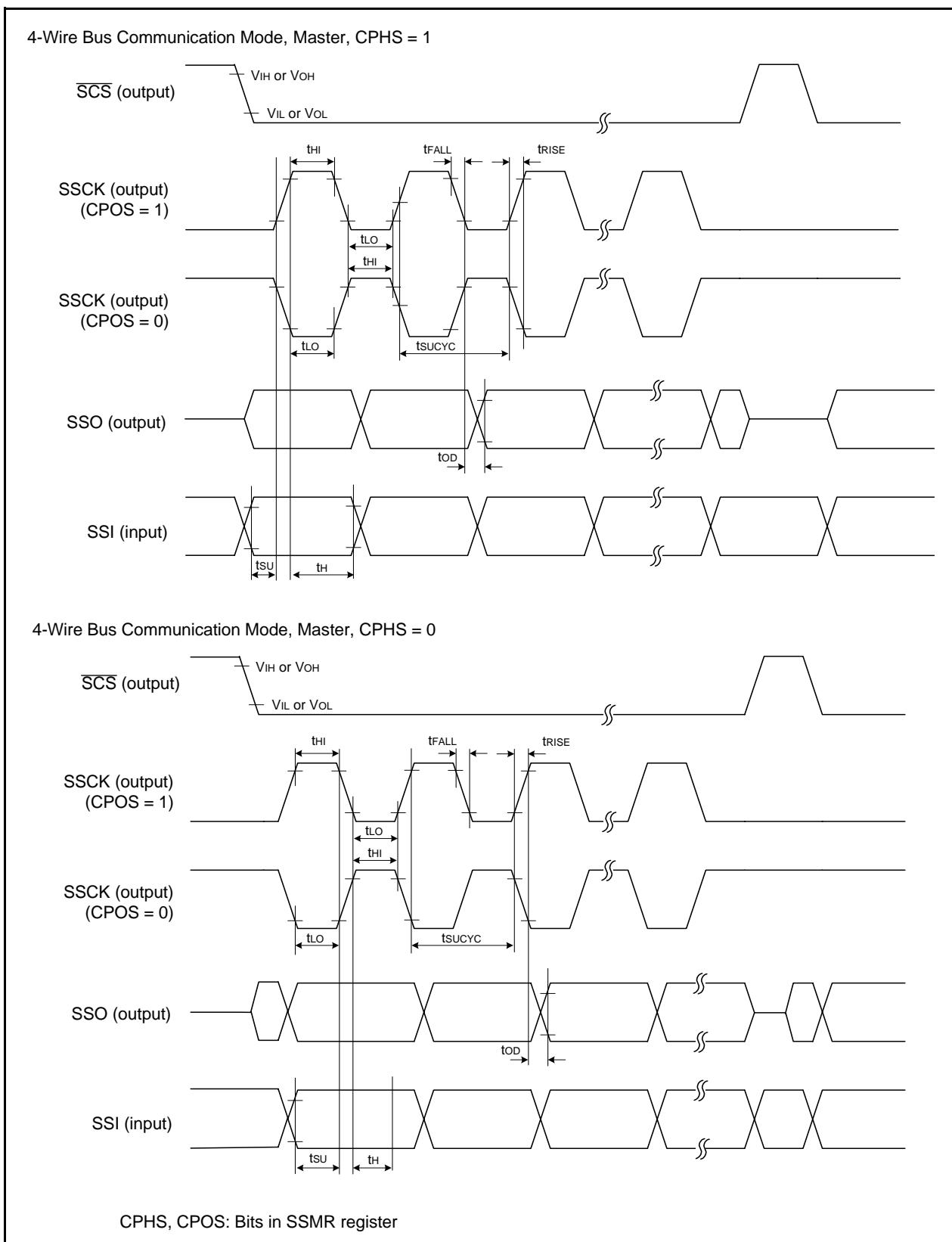
1. The measurement condition is Vcc = 1.8 V to 5.5 V and Topr = –20 to 85°C (N version) / –40 to 85°C (D version).
2. Select the voltage detection level with bits VD1S0 to VD1S3 in the VD1LS register.
3. Time until the voltage monitor 1 interrupt request is generated after the voltage passes V<sub>det1</sub>.
4. Necessary time until the voltage detection circuit operates when setting to 1 again after setting the VCA26 bit in the VCA2 register to 0.

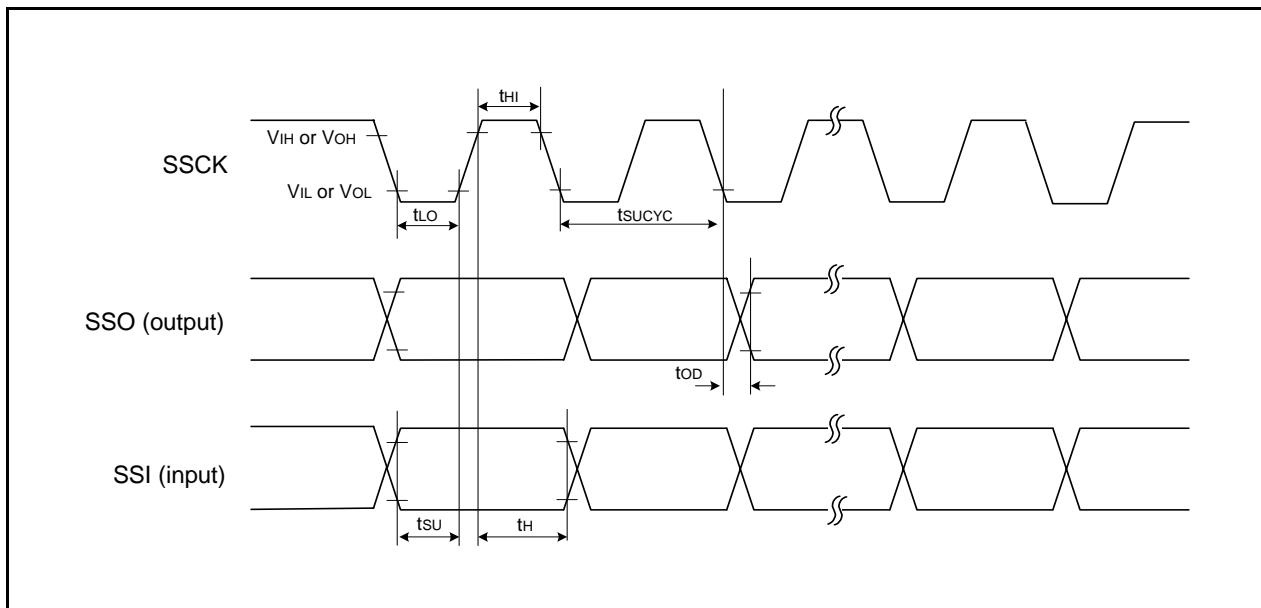
**Table 5.16 Timing Requirements of Synchronous Serial Communication Unit (SSU) (1)**

Symbol	Parameter	Conditions	Standard			Unit
			Min.	Typ.	Max.	
tsUCYC	SSCK clock cycle time		4	—	—	tcYC (2)
tH	SSCK clock "H" width		0.4	—	0.6	tsUCYC
tL0	SSCK clock "L" width		0.4	—	0.6	tsUCYC
tRISE	SSCK clock rising time	Master	—	—	1	tcYC (2)
		Slave	—	—	1	μs
tFALL	SSCK clock falling time	Master	—	—	1	tcYC (2)
		Slave	—	—	1	μs
tsu	SSO, SSI data input setup time		100	—	—	ns
tH	SSO, SSI data input hold time		1	—	—	tcYC (2)
tLEAD	SCS setup time	Slave	1tcYC + 50	—	—	ns
tLAG	SCS hold time	Slave	1tcYC + 50	—	—	ns
tOD	SSO, SSI data output delay time		—	—	1	tcYC (2)
tsA	SSI slave access time	2.7 V ≤ Vcc ≤ 5.5 V	—	—	1.5tcYC + 100	ns
		1.8 V ≤ Vcc < 2.7 V	—	—	1.5tcYC + 200	ns
tOR	SSI slave out open time	2.7 V ≤ Vcc ≤ 5.5 V	—	—	1.5tcYC + 100	ns
		1.8 V ≤ Vcc < 2.7 V	—	—	1.5tcYC + 200	ns

Notes:

1. Vcc = 1.8 to 5.5 V, Vss = 0 V and T<sub>opr</sub> = -20 to 85°C (N version) / -40 to 85°C (D version), unless otherwise specified.
2. 1tcYC = 1/f<sub>1</sub>(s)

**Figure 5.4 I/O Timing of Synchronous Serial Communication Unit (SSU) (Master)**



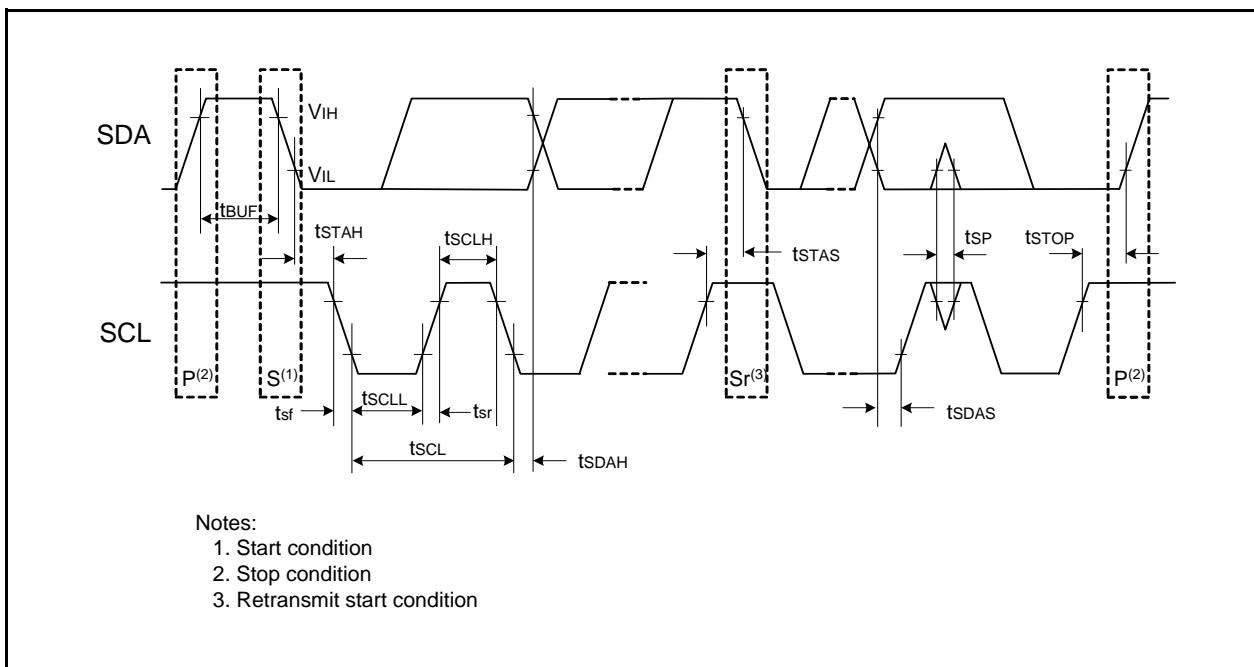
**Figure 5.6 I/O Timing of Synchronous Serial Communication Unit (SSU) (Clock Synchronous Communication Mode)**

**Table 5.17 Timing Requirements of I<sup>2</sup>C bus Interface (1)**

Symbol	Parameter	Condition	Standard			Unit
			Min.	Typ.	Max.	
tsCL	SCL input cycle time		12tCYC + 600 (2)	—	—	ns
tsCLH	SCL input "H" width		3tCYC + 300 (2)	—	—	ns
tsCLL	SCL input "L" width		5tCYC + 500 (2)	—	—	ns
tsf	SCL, SDA input fall time		—	—	300	ns
tSP	SCL, SDA input spike pulse rejection time		—	—	1tCYC (2)	ns
tBUF	SDA input bus-free time		5tCYC (2)	—	—	ns
tSTAH	Start condition input hold time		3tCYC (2)	—	—	ns
tSTAS	Retransmit start condition input setup time		3tCYC (2)	—	—	ns
tSTOP	Stop condition input setup time		3tCYC (2)	—	—	ns
tSDAS	Data input setup time		1tCYC + 40 (2)	—	—	ns
tSDAH	Data input hold time		10	—	—	ns

Notes:

1. V<sub>CC</sub> = 1.8 to 5.5 V, V<sub>SS</sub> = 0 V and T<sub>OPR</sub> = -20 to 85°C (N version) / -40 to 85°C (D version), unless otherwise specified.
2. 1tCYC = 1/f<sub>1</sub>(s)

**Figure 5.7 I/O Timing of I<sup>2</sup>C bus Interface**

**Table 5.19 Electrical Characteristics (2) [3.3 V ≤ Vcc ≤ 5.5 V]  
(Topr = –20 to 85°C (N version) / –40 to 85°C (D version), unless otherwise specified.)**

Symbol	Parameter	Condition	Standard			Unit
			Min.	Typ.	Max.	
Icc	Power supply current (Vcc = 3.3 to 5.5 V) Single-chip mode, output pins are open, other pins are Vss	High-speed clock mode	XIN = 20 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz No division	–	6.5	15 mA
			XIN = 16 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz No division	–	5.3	12.5 mA
			XIN = 10 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz No division	–	3.6	– mA
			XIN = 20 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz Divide-by-8	–	3.0	– mA
			XIN = 16 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz Divide-by-8	–	2.2	– mA
			XIN = 10 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz Divide-by-8	–	1.5	– mA
		High-speed on-chip oscillator mode	XIN clock off High-speed on-chip oscillator on fOCO-F = 20 MHz Low-speed on-chip oscillator on = 125 kHz No division	–	7.0	15 mA
			XIN clock off High-speed on-chip oscillator on fOCO-F = 20 MHz Low-speed on-chip oscillator on = 125 kHz Divide-by-8	–	3.0	– mA
			XIN clock off High-speed on-chip oscillator on fOCO-F = 4 MHz Low-speed on-chip oscillator on = 125 kHz Divide-by-16, MSTIIC = MSTTRD = MSTTRC = 1	–	1	– mA
		Low-speed on-chip oscillator mode	XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz Divide-by-8, FMR27 = 1, VCA20 = 0	–	90	400 μA
		Low-speed clock mode	XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator off XCIN clock oscillator on = 32 kHz No division, FMR27 = 1, VCA20 = 0	–	85	400 μA
			XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator off XCIN clock oscillator on = 32 kHz No division, Program operation on RAM Flash memory off, FMSTP = 1, VCA20 = 0	–	47	– μA
		Wait mode	XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz While a WAIT instruction is executed Peripheral clock operation VCA27 = VCA26 = VCA25 = 0 VCA20 = 1	–	15	100 μA
			XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz While a WAIT instruction is executed Peripheral clock off VCA27 = VCA26 = VCA25 = 0 VCA20 = 1	–	4	90 μA
			XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator off XCIN clock oscillator on = 32 kHz (peripheral clock off) While a WAIT instruction is executed VCA27 = VCA26 = VCA25 = 0 VCA20 = 1	–	3.5	– μA
		Stop mode	XIN clock off, Topr = 25°C High-speed on-chip oscillator off Low-speed on-chip oscillator off CM10 = 1, Peripheral clock off VCA27 = VCA26 = VCA25 = 0	–	2.0	5.0 μA
			XIN clock off, Topr = 85°C High-speed on-chip oscillator off Low-speed on-chip oscillator off CM10 = 1, Peripheral clock off VCA27 = VCA26 = VCA25 = 0	–	5.0 (1)	– μA
					15 (2)	

Notes:

- Value when the program ROM capacity of the product is 16 Kbytes to 32 Kbytes.
- Value when the program ROM capacity of the product is 48 Kbytes to 128 Kbytes.